

IR Receiver Modules for Remote Control Systems



16672

MECHANICAL DATA

Pinning

1 = OUT, 2 = V_S , 3 = GND

FEATURES

- Low supply current
- Photo detector and preamplifier in one package
- Internal filter for PCM frequency
- Improved shielding against EMI
- Supply voltage: 2.7 V to 5.5 V
- Improved immunity against ambient light
- Insensitive to supply voltage ripple and noise
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



DESCRIPTION

The TSOP21.. series are miniaturized receivers for infrared remote control systems. A PIN diode and a preamplifier are assembled on a lead frame, the epoxy package acts as an IR filter.

The demodulated output signal can directly be decoded by a microprocessor. The main benefit of the TSOP21.. is the compatibility to all IR remote control data formats.

This component has not been qualified according to automotive specifications.

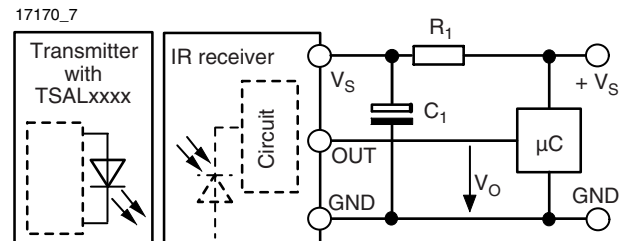
PARTS TABLE

| CARRIER FREQUENCY | SHORT BURSTS AND HIGH DATA RATES (AGC1) |
|-------------------|---|
| 30 kHz | TSOP2130 |
| 33 kHz | TSOP2133 |
| 36 kHz | TSOP2136 |
| 36.7 kHz | TSOP2137 |
| 38 kHz | TSOP2138 |
| 40 kHz | TSOP2140 |
| 56 kHz | TSOP2156 |

BLOCK DIAGRAM



APPLICATION CIRCUIT



The external components R_1 and C_1 are optional to improve the robustness against electrical overstress (typical values are $R_1 = 100 \Omega$, $C_1 = 0.1 \mu F$). The output voltage V_o should not be pulled down to a level below 1 V by the external circuit. The capacitive load at the output should be less than 2 nF.



| ABSOLUTE MAXIMUM RATINGS (1) | | | | |
|------------------------------|-------------------------------|-------------|--------------------------|------|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
| Supply voltage (pin 2) | | V_S | - 0.3 to + 6.0 | V |
| Supply current (pin 2) | | I_S | 5 | mA |
| Output voltage (pin 1) | | V_O | - 0.3 to 5.5 | V |
| Voltage at output to supply | | $V_S - V_O$ | - 0.3 to ($V_S + 0.3$) | V |
| Output current (pin 1) | | I_O | 5 | mA |
| Junction temperature | | T_j | 100 | °C |
| Storage temperature range | | T_{stg} | - 25 to + 85 | °C |
| Operating temperature range | | T_{amb} | - 25 to + 85 | °C |
| Power consumption | $T_{amb} \leq 85$ °C | P_{tot} | 10 | mW |
| Soldering temperature | $t \leq 10$ s, 1 mm from case | T_{sd} | 260 | °C |

Note

(1) Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

| ELECTRICAL AND OPTICAL CHARACTERISTICS (1) | | | | | | |
|--|--|----------------------|------|----------|------|-------------------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Supply current (pin 2) | $E_v = 0, V_S = 5$ V | I_{SD} | 0.65 | 0.85 | 1.05 | mA |
| | $E_v = 40$ klx, sunlight | I_{SH} | | 0.95 | | mA |
| Supply voltage | | V_S | 2.7 | | 5.5 | V |
| Transmission distance | $E_v = 0$, test signal see fig. 1, IR diode TSAL6200, $I_F = 400$ mA | d | | 45 | | m |
| Output voltage low (pin 1) | $I_{OSL} = 0.5$ mA, $E_e = 0.7$ mW/m ² , test signal see fig. 1 | V_{OSL} | | | 100 | mV |
| Minimum irradiance | Pulse width tolerance: $t_{pi} - 5/f_0 < t_{po} < t_{pi} + 6/f_0$, test signal see fig. 1 | $E_{e \text{ min.}}$ | | 0.17 | 0.35 | mW/m ² |
| Maximum irradiance | $t_{pi} - 5/f_0 < t_{po} < t_{pi} + 6/f_0$, test signal see fig. 1 | $E_{e \text{ max.}}$ | 30 | | | W/m ² |
| Directivity | Angle of half transmission distance | $\phi_{1/2}$ | | ± 45 | | deg |

Note

(1) $T_{amb} = 25$ °C, unless otherwise specified

TYPICAL CHARACTERISTICS

$T_{amb} = 25$ °C, unless otherwise specified

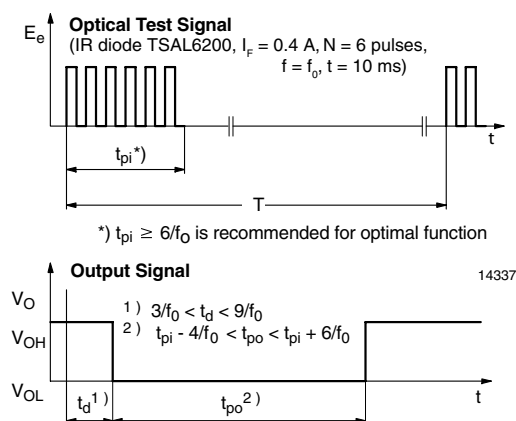


Fig. 1 - Output Active Low



Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

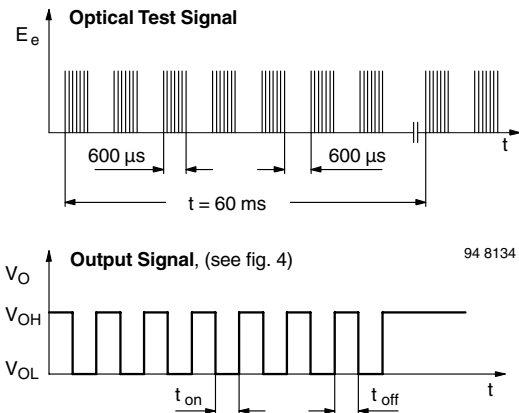


Fig. 3 - Output Function

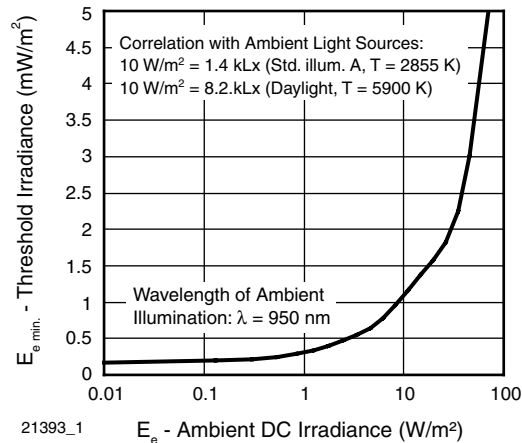


Fig. 6 - Sensitivity in Bright Ambient

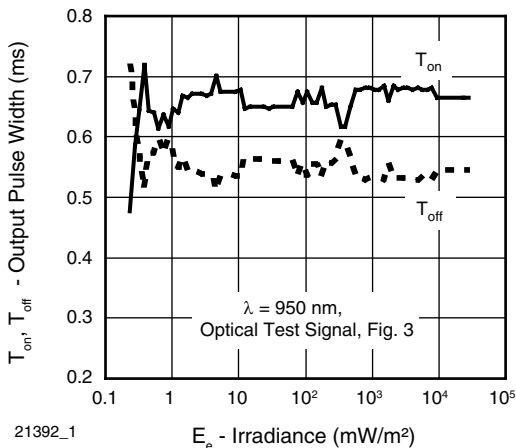


Fig. 4 - Output Pulse Diagram

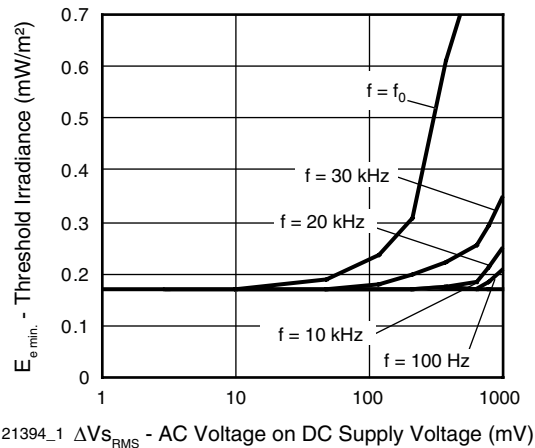


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

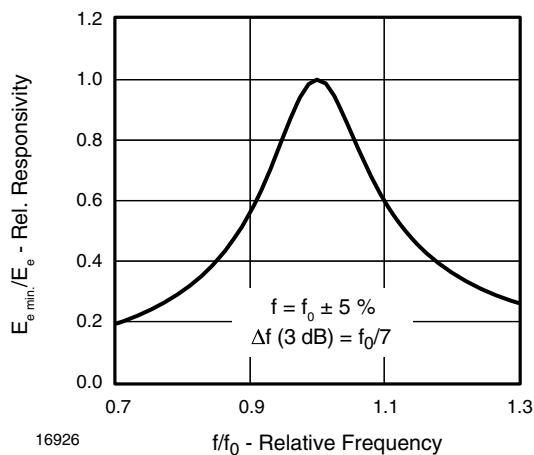


Fig. 5 - Frequency Dependence of Responsivity

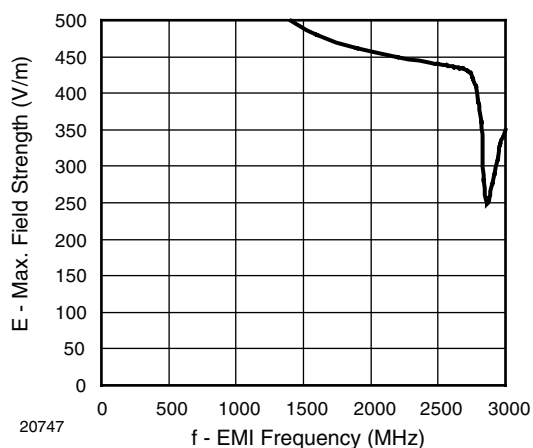
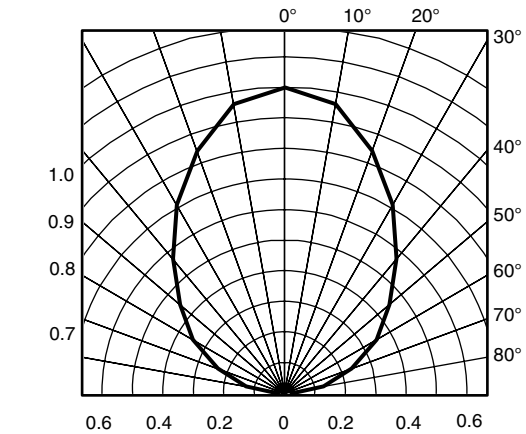


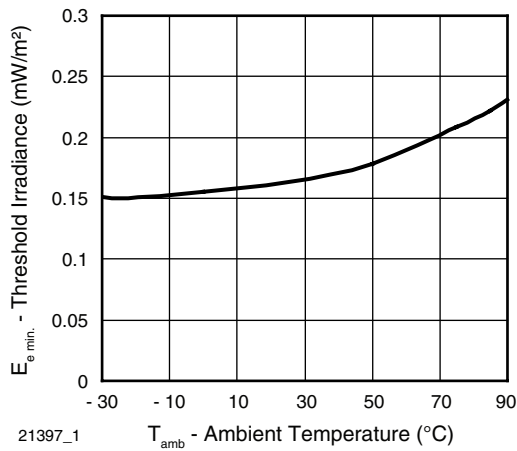
Fig. 8 - Sensitivity vs. Electric Field Disturbances



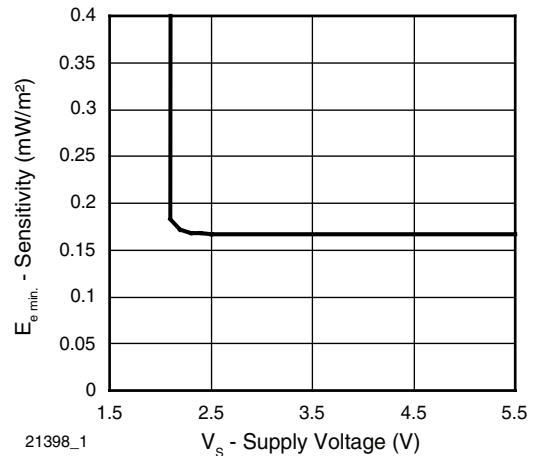
21396_1 Burst Length (number of cycles/burst)
Fig. 9 - Max. Envelope Duty Cycle vs. Burst Length



96 12223p2 d_{rel} - Relative Transmission Distance
Fig. 12 - Horizontal Directivity



21397_1 T_{amb} - Ambient Temperature (°C)
Fig. 10 - Sensitivity vs. Ambient Temperature



21398_1 V_s - Supply Voltage (V)
Fig. 13 - Sensitivity vs. Supply Voltage



16919 λ - Wavelength (nm)
Fig. 11 - Relative Spectral Sensitivity vs. Wavelength

SUITABLE DATA FORMAT

The TSOP21.. series is designed to suppress spurious output pulses due to noise or disturbance signals. Data and disturbance signals can be distinguished by the devices according to carrier frequency, burst length and envelope duty cycle. The data signal should be close to the band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the TSOP21.. in the presence of a disturbance signal, the sensitivity of the receiver is reduced to insure that no spurious pulses are present at the output. Some examples of disturbance signals which are suppressed are:

- DC light (e.g. from tungsten bulb or sunlight)
- Continuous signals at any frequency
- Modulated IR signals from common fluorescent lamps (example of noise pattern is shown in figure 14)

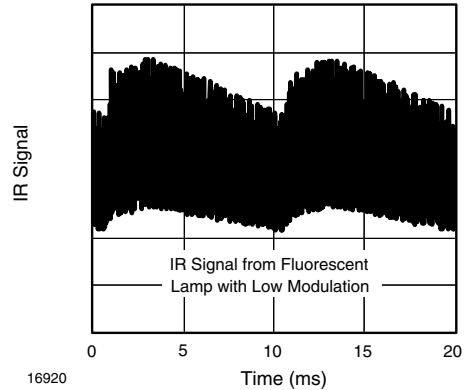


Fig. 14 - IR Signal from Fluorescent Lamp with Low Modulation

| | TSOP21.. |
|--|--|
| Minimum burst length | 6 cycles/burst |
| After each burst of length a minimum gap time is required of | 6 to 70 cycles ≥ 10 cycles |
| For bursts greater than a minimum gap time in the data stream is needed of | 70 cycles > 1.1 x burst length |
| Maximum number of continuous short bursts/second | 2000 |
| Compatible to NEC code | yes |
| Compatible to RC5/RC6 code | yes |
| Compatible to RCMM code | yes |
| Compatible to RECS-80 code | yes |
| Compatible to r-Step and r-Map data format | yes |
| Compatible to XMP data format | yes |
| Suppression of interference from fluorescent lamps | Most common disturbance signals are suppressed |

Note

For data formats with long bursts (10 carrier cycles or longer) we recommend the TSOP22.. because of the better noise suppression.

New TSOP21..

Vishay Semiconductors

IR Receiver Modules for
Remote Control Systems



PACKAGE DIMENSIONS in millimeters





OZONE DEPLETING SUBSTANCES POLICY STATEMENT

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA.
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design
and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany



Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)
Email: org@lifeelectronics.ru